Product/Process Change (PCN) Notification

PCN Number: CO-19232	Contact: Elizabeth La Greca
Date Issued: January 16th, 2018	Title: Director, Sales Operations
PCN Effective Date: April 16th, 2018	Phone: 1-858-795-0106
Product(s) Affected: PE4141	Email: pcn@psemi.com
Sample Availability: January 16th, 2018	
Change Control Board Approval #: CO-19232	

Change Category:

☒ Wafer Fabrication Process	☐ Shipping/Labeling
☐ Design/Mask Change	☐ Equipment
☐ Singulation Process	☐ Material
☐ Assembly Process	☐ Product Specification
☐ Electrical Test	☐ Product End of Life
☒ Manufacturing Site	☒ Other - Ordering codes change

Purpose of Change:

To enable Lapis as the primary wafer fabrication site for the PE4141. Peregrine Semiconductor Corp. (PSC) in San Diego will be the new backgrind location for the Lapis PE4141 material.

Description of Change:

We have been working to transfer products from Silanna fab in Australia to Lapis fab in Japan to ensure continuous supply. Silanna and Lapis are qualified Peregrine fabs. Peregrine Semiconductor Corp. (PSC) in San Diego will be replacing Silanna as the new backgrind location for the Lapis PE4141 material.

Lapis PE4141 material has been qualified with no change to form, fit, function or reliability.

Beginning April 16th, 2018, the PE4141 shipped to customers will be supplied from either Silanna or Lapis wafers. Lapis will become the primary wafer fabrication site for the PE4141.

Ordering code changes:

Original ordering codes (Silanna): 4141-51, 4141-52, 4141-00

New ordering codes (Lapis): PE4141B-W, EK4141-02

Product/Process Change (PCN) Notification

Customer Acknowledgement of Receipt:

☐ Change Denied *(Include explanation in comments section below)* ☐ Change Approved	**Name:**	
	Title:	
	Company:	
	Date:	
	Signature:	
Customer Comments:		